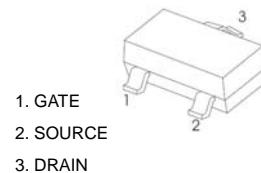


Plastic-Encapsulate MOSFETS

N-Channel, 20V, 0.89A, Small Signal MOSFET

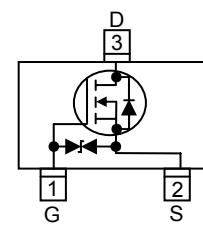
V_{DS} (V)	R_{ds(on)} (Ω)	I_D (A)
20	0.220@ V _{GS} =4.5V	0.55
	0.260@ V _{GS} =2.5V	0.45
	0.320@ V _{GS} =1.8V	0.35

SOT-23



Descriptions

The CB2021 is N-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent R_{DS (ON)} with low gate charge. This device is suitable for use in DC-DC conversion, load switch and level shift. Standard Product CB2021 is Pb-free.



Pin configuration (Top view)

Features

Marking = 21

- Trench Technology
- Supper high density cell design
- Excellent ON resistance
- Extremely Low Threshold Voltage
- Small package SOT-23

Applications

- DC-DC converter circuit
- Small Signal Switch
- Load Switch
- Level Shift

Absolute Maximum ratings

Parameter	Symbol	10 S	Steady State	Unit
Drain-Source Voltage	V _{DS}	20	±6	V
Gate-Source Voltage	V _{GS}			
Continuous Drain Current ^a	T _A =25°C	I _D	0.89	A
	T _A =70°C		0.71	
Maximum Power Dissipation ^a	T _A =25°C	P _D	0.37	W
	T _A =70°C		0.23	
Continuous Drain Current ^b	T _A =25°C	I _D	0.78	A
	T _A =70°C		0.62	
Maximum Power Dissipation ^b	T _A =25°C	P _D	0.29	W
	T _A =70°C		0.18	
Pulsed Drain Current ^c	I _{DM}	1.4		A
Operating Junction Temperature	T _J	150		°C
Lead Temperature	T _L	260		°C
Storage Temperature Range	T _{stg}	-55 to 150		°C

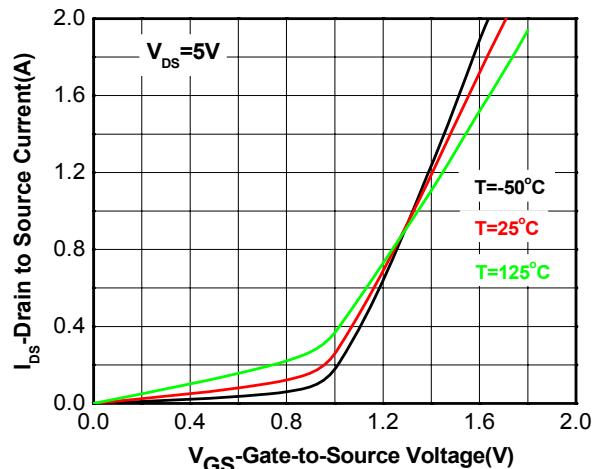
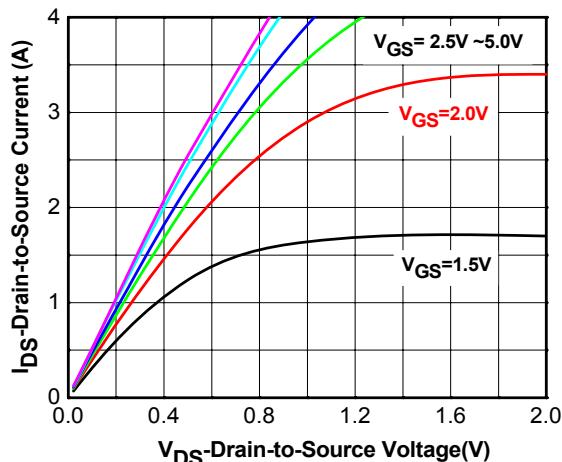
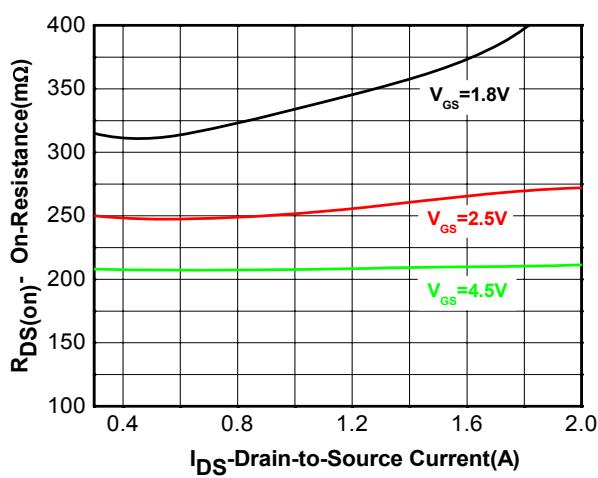
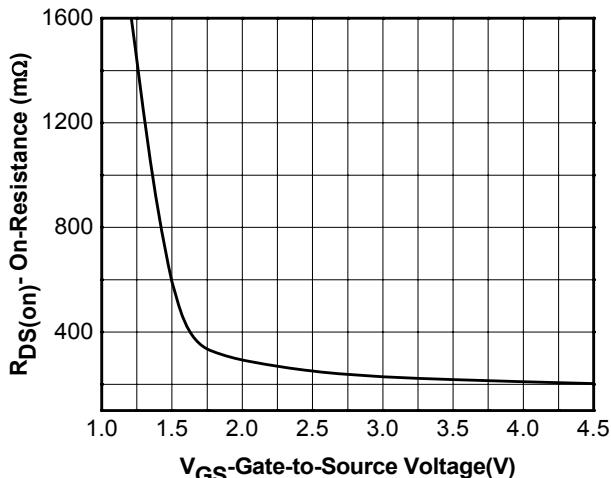
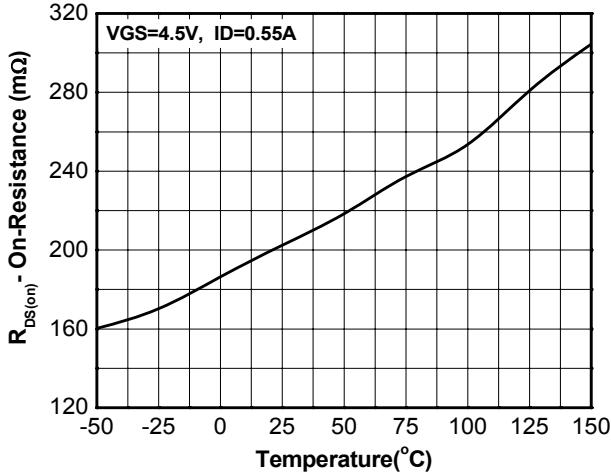
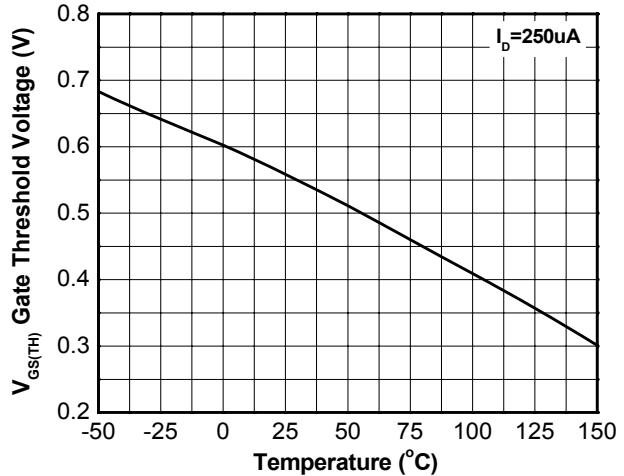
Thermal resistance ratings

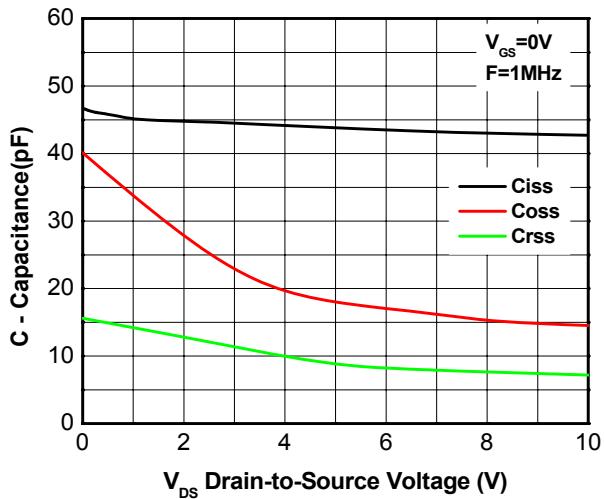
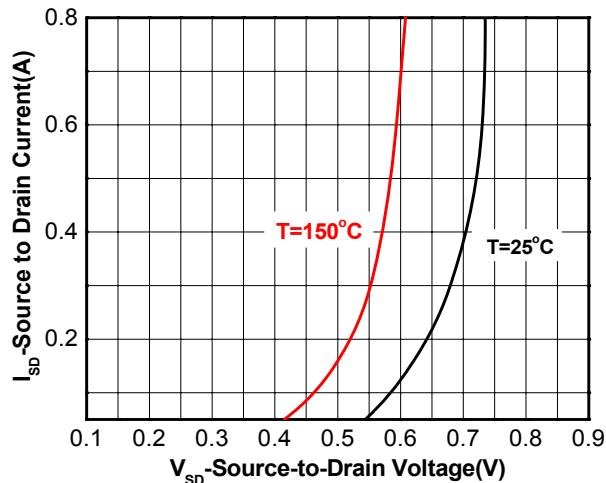
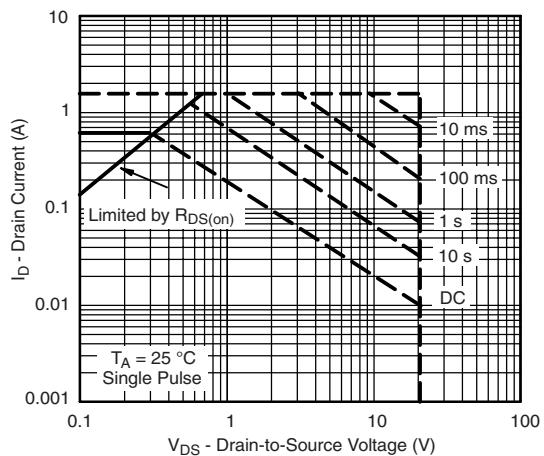
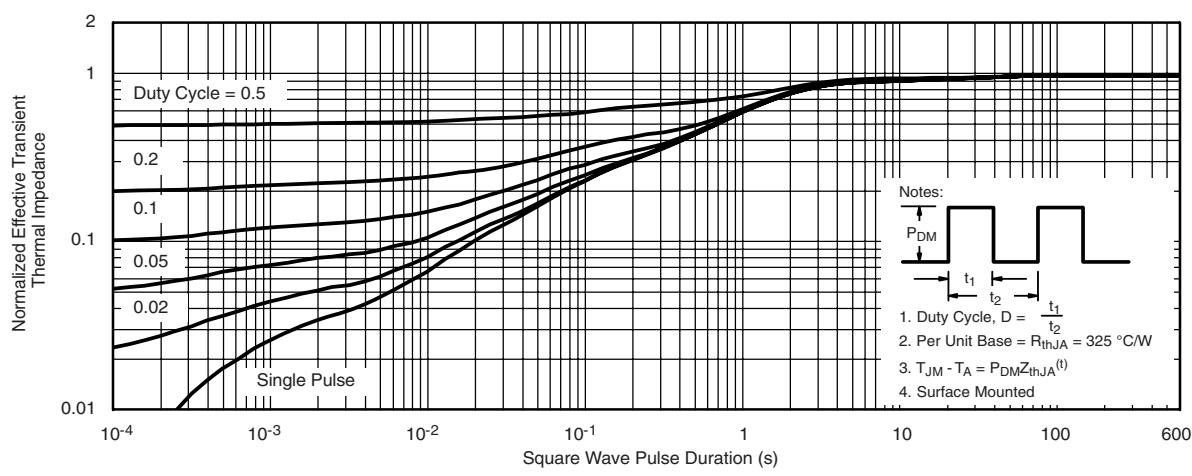
Parameter	Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance ^a	t ≤ 10 s	R _{θJA}	275	335
	Steady State		325	
Junction-to-Ambient Thermal Resistance ^b	t ≤ 10 s	R _{θJA}	375	430
	Steady State		445	
Junction-to-Case Thermal Resistance	R _{θJC}	260	300	°C/W

- ^a Surface mounted on FR4 Board using 1 square inch pad size, 1oz copper
^b Surface mounted on FR4 board using minimum pad size, 1oz copper
^c Repetitive rating, pulse width limited by junction temperature, t_p=10μs, Duty Cycle=1%
^d Repetitive rating, pulse width limited by junction temperature T_J=150°C.

Electronics Characteristics (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0 \text{ V}, I_D = 250\mu\text{A}$	20			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 16 \text{ V}, V_{GS} = 0\text{V}$			100	nA
Gate-to-source Leakage Current	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 5\text{V}$			5	μA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$	0.45	0.58	0.85	V
Drain-to-source On-resistance	$R_{DS(on)}$	$V_{GS} = 4.5\text{V}, ID = 0.55\text{A}$		220	260	$\text{m}\Omega$
		$V_{GS} = 2.5\text{V}, ID = 0.45\text{A}$		260	310	
		$V_{GS} = 1.8\text{V}, ID = 0.35\text{A}$		320	380	
Forward Transconductance	g_{FS}	$V_{DS} = 5 \text{ V}, ID = 0.55\text{A}$		2.0		S
CHARGES, CAPACITANCES AND GATE RESISTANCE						
Input Capacitance	C_{ISS}	$V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}, V_{DS} = 10 \text{ V}$		50		pF
Output Capacitance	C_{OSS}			13		
Reverse Transfer Capacitance	C_{RSS}			8		
Total Gate Charge	$Q_{G(TOT)}$	$V_{GS} = 4.5 \text{ V}, V_{DS} = 10 \text{ V}, I_D = 0.55\text{A}$		1.15		nC
Threshold Gate Charge	$Q_{G(TH)}$			0.06		
Gate-to-Source Charge	Q_{GS}			0.15		
Gate-to-Drain Charge	Q_{GD}			0.23		
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	$td(\text{ON})$	$V_{GS} = 4.5 \text{ V}, V_{DS} = 10\text{V}, R_L=3 \Omega, R_G=6 \Omega$		22		ns
Rise Time	tr			80		
Turn-Off Delay Time	$td(\text{OFF})$			700		
Fall Time	tf			380		
BODY DIODE CHARACTERISTICS						
Forward Voltage	V_{SD}	$V_{GS} = 0 \text{ V}, I_S = 0.35\text{A}$	0.5	0.7	1.1	V

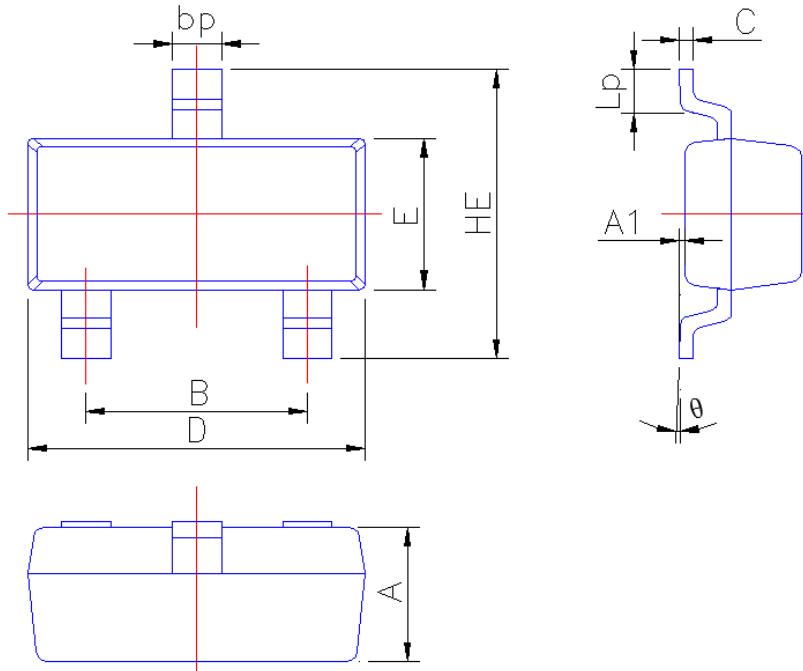
Typical Characteristics (Ta=25°C, unless otherwise noted)

Output characteristics

Transfer characteristics

On-Resistance vs. Drain current

On-Resistance vs. Junction temperature
On-Resistance vs. Gate-to-Source voltage

Threshold voltage vs. Temperature


Capacitance

Body diode forward voltage

Safe operating power

Transient thermal response (Junction-to-Ambient)

PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT-23



Symbol	Dimension in Millimeters	
	Min	Max
A	0.90	1.10
A1	0.013	0.100
B	1.80	2.00
bp	0.35	0.50
C	0.09	0.150
D	2.80	3.00
E	1.20	1.40
HE	2.20	2.80
Lp	0.20	0.50
θ	0°	5°